

### 0.4~3.8GHz 3xSPST Antenna Tuning Switch

# **Description**

The MXD8533B is a CMOS silicon-on-insulator (SOI), three single-pole, single-throw (3xSPST) switch. The high linearity and ruggedness performance and extremely low  $R_{\text{ON}}$  and  $C_{\text{OFF}}$  makes the device an ideal choice for GSM/WCDMA/LTE handset antenna tuning application.

The MXD8533B 3xSPST switch is provided in a compact 1.75mm x 1.66mm x 0.37mm package. A functional block diagram, the pin configuration and package are shown in Figure 1. Signal pin assignments and functional pin descriptions are provided in Table 1.

# **Applications**

- GSM/WCDMA/LTE band and mode switching
- Antenna tuning switching

### **Features**

- Broadband frequency range: 0.4 to 3.8 GHz
- Input 0.1dB Compression Point: 48dBm
- RFFE serial control interface
- No DC blocking capacitors required
- Ultra small package, LGA 11-pin (1.75mm x 1.66mm x 0.37mm), MSL1

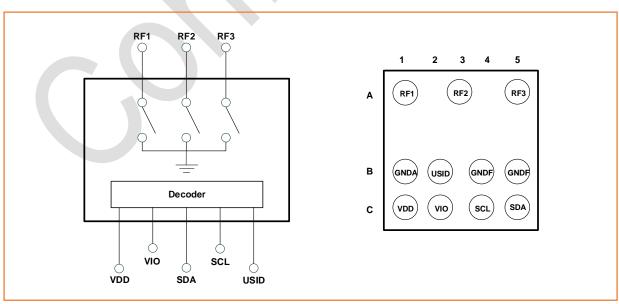


Figure 1 Functional Block Diagram

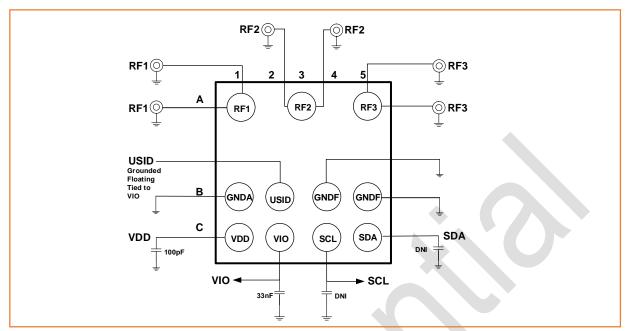


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# **Function Characteristics**



**Figure 2 Application Circuit** 

**Table 1 Pin Descriptions** 

NO.	Name	Description	NO.	Name	Description
<b>A</b> 1	RF1	RF Port1	B5	GNDF	RF Ground
А3	RF2	RF Port2	C1	VDD	DC Supply Voltage
A5	RF3	RF Port3	C2	VIO	Supply Voltage for MIPI
B1	GNDA	Analog Ground	C4	SCL	MIPI Clock
B2	USID	Unique Salve ID	C5	SDA	MIPI Data Input/output
B4	GNDF	RF Ground			

Table 2 Register\_0[7:0] (MIPI Data) for RF Operating Mode

State	Mode				Regis	ster_0			
		D7	D6	D5	D4	D3	D2	D1	D0
1	All On	0	0	0	0	0	1	1	1
2	RF1 On	0	0	0	0	0	1	0	0
3	RF2 On	0	0	0	0	0	0	1	0
4	RF3 On	0	0	0	0	0	0	0	1
5	RF1+RF2 On	0	0	0	0	0	1	1	0
6	RF1+RF3 On	0	0	0	0	0	1	0	1
7	RF2+RF3	0	0	0	0	0	0	1	1
8	All Off	0	0	0	0	0	0	0	0



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### **Electrical Characteristics**

**Table 3 Absolute Maximum Ratings** 

Parameter	Symbol	Min	Max	Unit		
DC Supply Voltage	$V_{ exttt{DD}}$	-0.3	3.6			
Supply Voltage for MIPI	V <sub>IO</sub>	-0.3	+2.5	V		
MIPI Control Voltage(SDA, SCL)	Vı	-0.3	+2.5			
RF Input Peak Power(VSWR 1:1,20% DC)	P <sub>IN</sub>		+48.5	dBm		
Device Operating Temperature	T <sub>OP</sub>	-40	+90	°C		
Device Storage Temperature	T <sub>STG</sub>	-55	+150			
Electrostatic Discharge						
Human Body Model (HBM), Class 1C	V <sub>ESD(HBM)</sub>	1000		V		
Charged Device Model (CDM), Class III	V <sub>ESD(CDM)</sub>	500		V		

#### Notice

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**Table 4 Recommended Operating Conditions** 

Parameter	Symbol	MIN	TYP	MAX	Unit
Operating Frequency	F <sub>0</sub>	0.4		3.8	GHz
DC Supply Voltage	<b>V</b> <sub>DD</sub>	1.7	2.8	3.3	
Power Supply for MIPI	V <sub>IO</sub>	1.62	1.8	1.98	V
MIPI Control Voltage(SDA, SCL) High	V <sub>IH</sub>	0.8*VIO	VIO	VIO	V
MIPI Control Voltage(SDA, SCL) Low	V <sub>IL</sub>	0	0	0.3	



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**Table 5 Nominal Operating Parameters** 

Parameter	Symbol	Specification		Unit	Condition				
		MIN	TYP	MAX					
Normal Condition	$\textbf{Normal Condition} \qquad \qquad \textbf{V}_{DD} = 2.8 \text{V}, \ \textbf{V}_{IO} = 1.8 \text{V}, \ \textbf{V}_{IH} = 1.8 \text{V}, \ \textbf{V}_{IL} = 0 \text{V}, \ \textbf{P}_{IN} = 0 \text{dBm}, \ \textbf{Z}_O = 50 \Omega, \ \textbf{T}_A = 25 ^{\circ} \textbf{C}, \ \textbf{Unless Otherwise Stated}$								
			DC Perfo	rmances					
DC Supply Current	I <sub>DD</sub>		100	200	μΑ				
Current on VIO	I <sub>IO</sub>		5	10	μΑ				
		Т	iming Per	formance	es				
Switching Speed	T <sub>SW</sub>		15	25	μs	End of MIPI Command to 90%/10% RF			
Startup Time	Ton		30		μs	MIPI Low Power State to any RF			
			RF Perfo	rmances					
		40	45			F₀=0.8 to 1.0GHz			
Isolation	ISO	35	38		dB	F₀=1.0 to 2.2GHz			
(All off mode, RFx to RFy)	130	33	36		ub	F₀=2.2 to 3.0GHz			
		29	32			F₀=3.4 to 3.8GHz			
On Resistance	R <sub>on</sub>		1.9	2.0	Ω	Switch on Path @DC			
OFF Capacitance	C <sub>OFF</sub>		100	120	fF	Switch off Path @500MHz			
Input 0.1dB Compression Point	P <sub>0.1dB</sub>		+48		dBm	F₀=950MHz, 20% DC			
Peak RF Operating Voltage	$V_{RF}$		80		v	F₀=950MHz, until 3F₀ Nonlinear Isolation Mode			
LTC TV Hammania	2F <sub>0</sub>	-70	-85		dBm	F =700 to 0700MHz @ 100dP			
LTE TX Harmonic	3F <sub>0</sub>	-70	-85		dBm	F₀=700 to 2700MHz @+26dBm			
GSM LB Harmonic	2F <sub>0</sub>	-55	-65		dBm	E =024 to 045MU= @125dDm			
GSWI LB Harmonic	3F <sub>0</sub>	-55	-65		dBm	- F₀=824 to 915MHz @+35dBm			
GSM HB Harmonic	2F <sub>0</sub>	-55	-65		dBm	F₀=1710 to 2690MHz @+33dBm			
GOW I'D HAITHUING	3F <sub>0</sub>	-55	-65		dBm	F <sub>0</sub> −17 to to 2030MIT2 @+330BIII			
2nd Order Intermodulation	IMD2	-105	-115		dBm	Reference to Table 6			
3rd Order Intermodulation	IMD3	-105	-115		dBm	Reference to Table 7			

#### **Table 6 IMD2 Test Conditions**

Band	In-band Frequency	CW C	arrier	CW Into	erferer
	MHz	MHz	dBm	MHz	dBm
1 Low	2140	1950	+20	190	-15
1 High	2140	1950	+20	4090	-15
5 Low	881.5	836.5	+20	45	-15
5 High	881.5	836.5	+20	1718	-15

#### **Table 7 IMD3 Test Conditions**

Band	In-band Frequency	CW C	Carrier	CW Interferer		
	MHz	MHz	dBm	MHz	dBm	
1 LOW	2140	1950	+20	1760	-15	
5 HIGH	881.5	836.5	+20	791.5	-15	



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## **MIPI Read and Write Timing**

MIPI supports the following Command Sequences:

- Register Write
- Register Read
- Register\_0 Write

Figure 3 and Figure 4 illustrate the timing diagrams for register write command sequence and read command sequence, respectively. Figure 5 describes the Register\_0 write command sequence.

Other information such as MIPI USID programming sequences, MIPI bus specifications, etc. can be referred to the MIPI Alliance Specification for RF Front-End Control Interface (RFFE), V1.10 (26 July 2011) and the subsequent versions.

In the below timing figures, SA[3:0] is the slave address. A[4:0] denotes the register address. D[7:0] means the data. "P" is a parity bit.

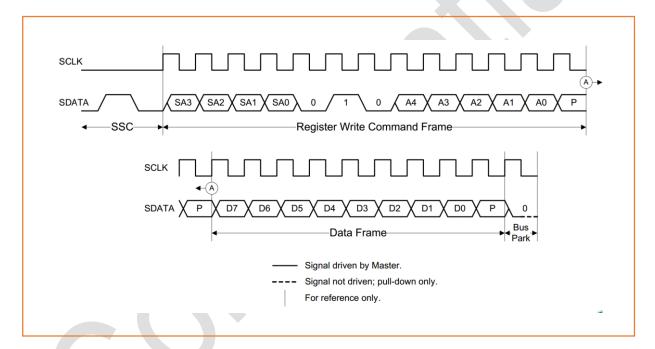
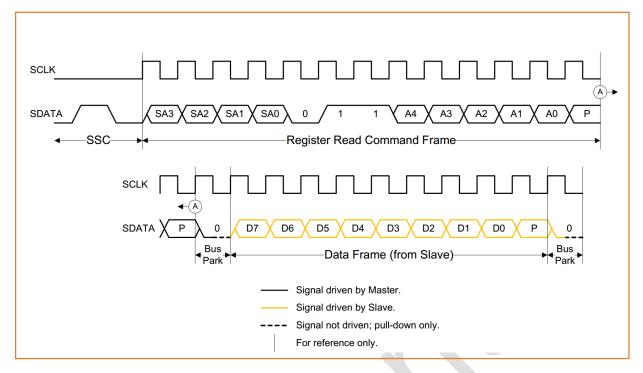


Figure 3 Register Write Command Sequence

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**Figure 4 Register Read Command Sequence** 

# Register\_0 Write Command Sequence

Figure 5 shows the Register\_0 Write Command Sequence. The Command Sequence starts with an SSC, followed by the Register 0 Write Command Frame containing the Slave address, a logic '1' (to denote the command type and address), and a 7-bit word to be written into Register 0. The Command Sequence ends with a Bus Park Cycle

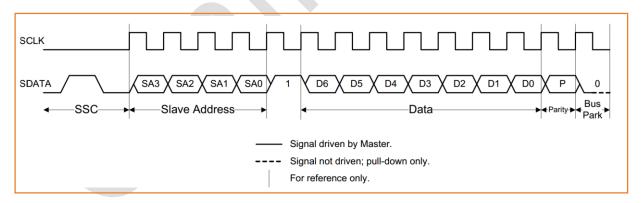


Figure 5 Register\_0 Write Command Sequence

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# **Register Definition**

Table 8 Register definition table

				14510 0 11	egister definition table			
Register Address	Register Name	Data Bits	R/W	Function	Description	Default	BROADC  AST_ID  support	Trigger support
0x0000	REGISTER_0	7:0	R/W	RF Control	Register_0 truth Table: Table 2	0x00	No	Yes
	7	R/W	SOFTWARE RESET	O: Normal operation  1: Software reset  Note: On software reset, this register and all configurable registers are reset except for USID, GSID, and PM_TRIG.	060	No	No	
		6	R/W	COMMAND_FR  AME_PARITY_  ERR	Command Frame with parity error	0b0	No	No
		5	R/W	COMMAND_LE	Command Sequence with incorrect length	0b0	No	No
0x001A	RFFE_STATU 001A S	4	R/W	ADDRESS_FRA ME_PARITY_E RR	Address Frame with parity error	0b0	No	No
	3	R/W	DATA_FRAME_ PARITY_ERR	Data Frame with parity error	0b0	No	No	
		2	R/W	READ_UNUSE D_REG	Read Command Sequence to an invalid address	0b0	No	No
		1	R/W	WRITE_UNUSE D_REG	Write Command Sequence to an invalid address	0b0	No	No
		0	R/W	BID_GID_ERR	Read Command Sequence with a BSID or GSID Note: Reading this register resets this register.	0b0	No	No
0 004B	ODOUD OID	7:4	R	RESERVED		0x0	No	No
0x001B	GROUP_SID	3:0	R/W	GSID	Group Slave ID	0x0	No	No
0x001C	PM_TRIG	7:6	R/W	PWR_MODE	00: Normal Operation (ACTIVE) 01: Reset all registers to default settings (STARTUP) 10: Low power (LOW POWER) 11: Reserved Note: Write PWR_MODE[1:0]=0b01 will reset all register, and then automatically put the device into ACTIVE state.	0ь00	Yes	No
		5	R/W	Trigger_Mask_	If this bit is set, trigger 2 is disabled	0b0	No	No

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Register Address	Register Name	Data Bits	R/W	Function	Description	Default	BROADC AST_ID support	Trigger support
		4	R/W	Trigger_Mask_ 1	If this bit is set, trigger 1 is disabled	0b0	No	No
		3	R/W	Trigger_Mask_ 0	If this bit is set, trigger 0 is disabled  Note: When all triggers are disabled, writing to a register that is associated with trigger 0, 1, or 2, causes the data to go directly to the destination register.	0b0	No	No
		2	w	Trigger_2	A write of a one to this bit loads trigger 2's registers	0b0	Yes	No
		1	w	Trigger_1	A write of a one to this bit loads trigger 1's registers	0Ь0	Yes	No
		0	w	Trigger_0	A write of a one to this bit loads trigger 0's registers Note: Trigger processed immediately then cleared. Trigger 0, 1, and 2 will always read as 0.	0ь0	Yes	No
0x001D	PRODUCT_ID	7:0	R	PRODUCT_ID	Product Number	0x34	No	No
0x001E	MANUFACTU RER_ID	7:0	R	MANUFACTUR ER_ID[7:0]	Lower eight bits of MIPI registered  Manufacturer ID	0x81	No	No
		7:6	R	RESERVED		0b00	No	No
		5:4	R	MANUFACTUR ER_ID[9:8]	Upper two bits of MIPI registered  Manufacturer ID	0b11	No	No
0x001F	MAN_USID	3:0	R/W	USID	User Identification, with USID tied to	0x6	No	No
		3:0	IT/W	บงเม	User Identification, with USID floated	0x7	No	No
					User Identification, with USID tied to VIO	0x9	No	No

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### **Power On and Off Sequence**

Here is the recommendation for power-on and power-off sequence in order to avoid damaging to the device.

#### **Power On**

- 1) Apply voltage supply VDD
- 2) Apply logic supply VIO
- 3) Wait 30µs or longer and then apply MIPI bus signals SCL and SDA
- 4) Wait 25µs or longer after MIPI bus goes idle and then apply the RF Signal

#### **Power Off**

- 1) Remove the RF Signal
- 2) Remove MIPI bus SCL and SDA
- 3) Remove logic supply VIO
- 4) Remove voltage supply VDD

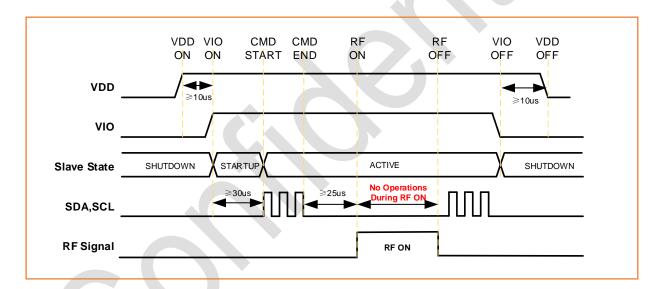


Figure 6 Power On and Off Sequence

#### Notice

- VIO can also be applied to the device before VDD or removed after VDD.
- It is important not to send any SDA until a 10us or longer waiting time following the VDD and VIO startup to ensure corrective data transmission.
- Operations of SDA or SCL are strictly prohibited during RF On period so as to prevent the device being damaged.
- The minimum time between a power up and power down sequence (and vice versa) shall be 100us or longer.



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# **Package Outline Dimensions**

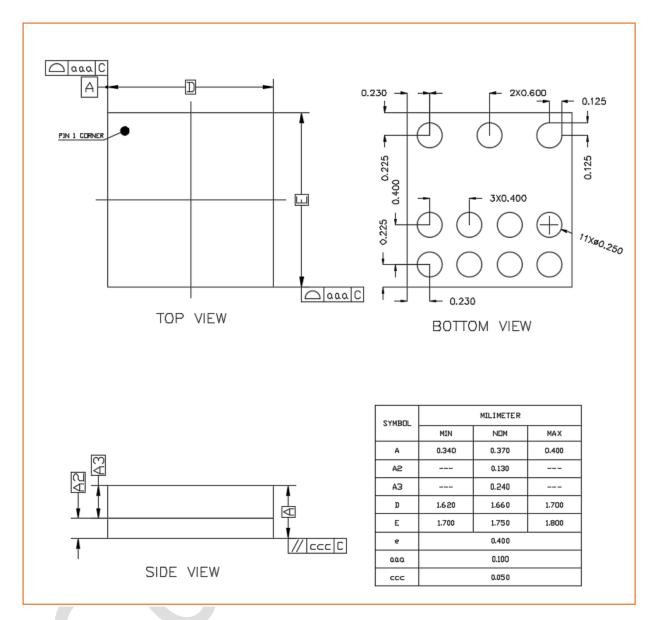


Figure 7 Package Outline Dimensions

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# **Marking Specification**

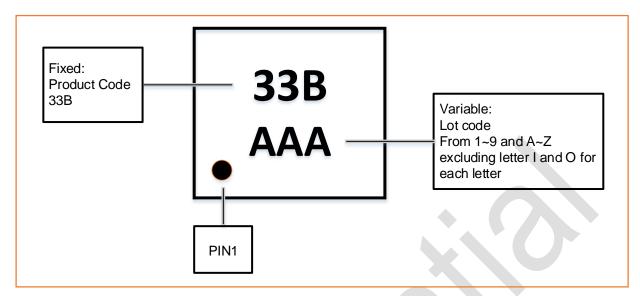


Figure 8 Marking Specification (Top View)

# **Tape and Reel Dimensions**

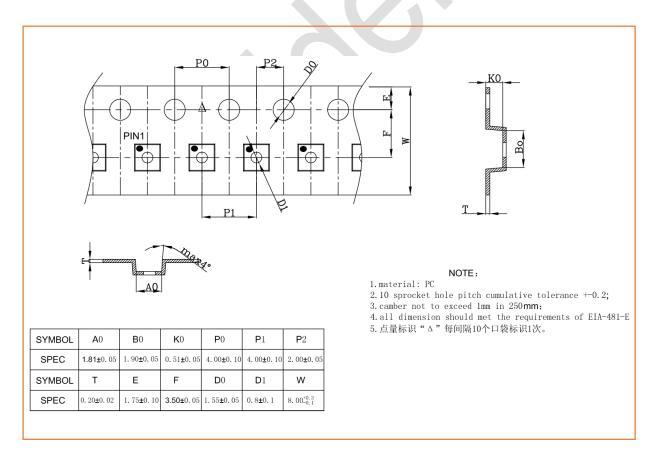


Figure 9 Tape and Reel Dimensions



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### **Reflow Chart**

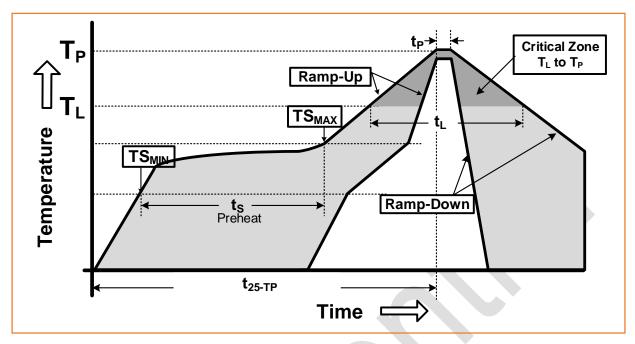


Figure 10 Recommended Lead-Free Reflow Profile

**Table 9 Reflow Chart Parameters** 

Reflow Profile	Parameter		
Preheat Temperature(TS <sub>MIN</sub> to TS <sub>MAX</sub> )	150℃ to 200℃		
Preheat Time(ts)	60 to 180 Seconds		
Ramp-Up Rate(TS <sub>MAX</sub> to T <sub>P</sub> )	3°C/s MAX		
Time Above T <sub>L</sub> 217°C(t <sub>L</sub> )	60 to 150 Seconds		
Peak Temperature ( T <sub>P</sub> )	260℃		
Time within 5°C of Peak Temperature(t₀)	20 to 40 Seconds		
Ramp-Down Rate(TS <sub>MAX</sub> to T <sub>P</sub> )	6℃/s MAX		
Time for 25°C to Peak Temperature(t <sub>25-TP</sub> )	8 Minutes MAX		

# **ESD Sensitivity**

Integrated circuits are ESD sensitive and can be damaged by static electric charge. Proper ESD protection techniques should be applied when devices are operated.

# **RoHS Compliant**

This product does not contain lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE), and are considered RoHS compliant.



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MA4AGSW3 MA4AGSW5 MA4SW210B-1 MA4SW410 MASW-002102-13580G BGS 12PL6 E6327 BGS1414MN20E6327XTSA1

BGS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8 HMC595AETR HMC986A

SKY13374-397LF SKY13453-385LF CG2430X1-C2 TGS4304 UPG2162T5N-A CG2415M6-C2 AS222-92LF SW-314-PIN

UPG2162T5N-E2-A BGS18GA14E6327XTSA1 MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588
TR3000 MASW-007075-000100 MASW-004103-13655P MASW-003102-13590G MASWSS0202TR-3000 MASW-008543-TR3000

MA4SW310B-1